

FEATURES

- high power applications
- highly configurable, versatile DSP platform
- high fidelity multi-channel AGC signal processing
- 95dB input dynamic range with HRX™ Headroom Extension
- fully programmable via serial data interface
- high performance data converters – dual, over-sampled A/Ds; over-sampled D/A with efficient switched-mode output power amp
- SOUNDDESIGN™ high-fidelity audio quality
- drives zero-bias 2-terminal receivers
- multiple communication rates up to 85.3kb/s
- multi-memory
- internal/external volume control
- volume control taper determined by external VC
- 2 memory select pads
- tri-state memory select operation
- audible memory change indicator

thinSTAX™ PACKAGING

Hybrid typical dimensions:

0.227 x 0.125 x 0.060 in
(5.76 x 3.18 x 1.52 mm)

DESCRIPTION

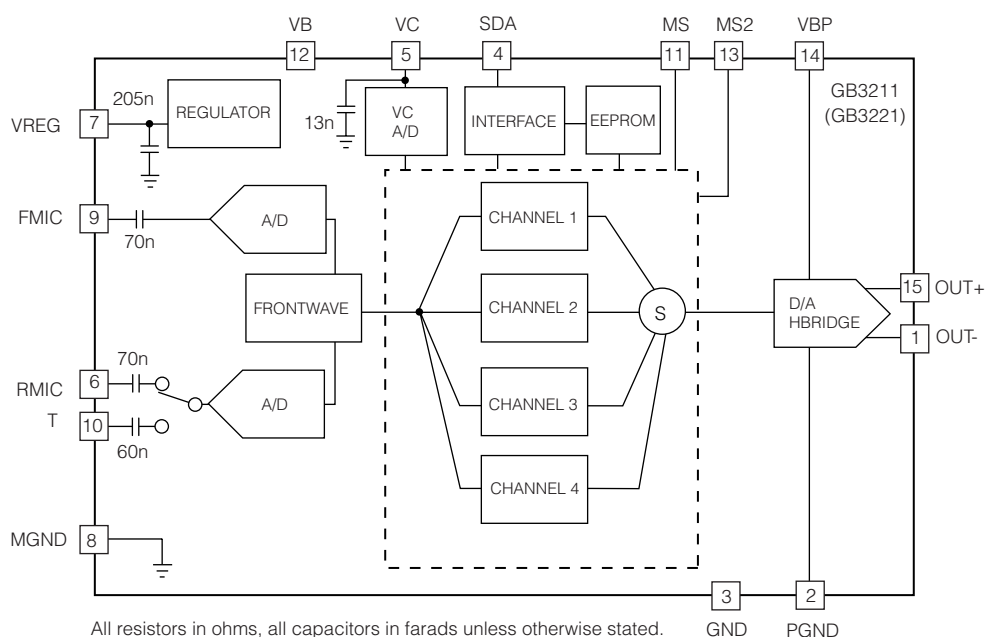
The GB3211 (GB3221) hybrid is a programmable DSP system based on a multi-channel compression circuit. This hybrid is designed for low impedance receivers. It can be used as a platform for a wide range of hearing aid applications. It also offers a separate supply line to the A/D and H-Bridge circuits. The reflowable thinSTAX™ packaging enables easy integration into BTE applications. This versatile DSP hybrid is capable of multiple configurations and has a wide range of functions.

The GB3211 hybrid contains the GC5051 controller chip and the GB3221 hybrid contains the GC5057 controller chip. The only difference between the GC5051 and the GC5057 is in their Power On Reset (POR) behaviour.

For a detailed description of the POR behaviour of the GC5051 and GC5057 controller chips, please refer to [PARAGON™ DIGITAL Reference Guide](#), Document #20143.

The GB3211 and the GB3221 hybrid code programmed into the GC5051 and the GC5057 controller chips is "7".

This data sheet is a part of a set of documents available for this product. Please refer to [Getting Started with PARAGON™ DIGITAL](#) information note for a list of other documents.

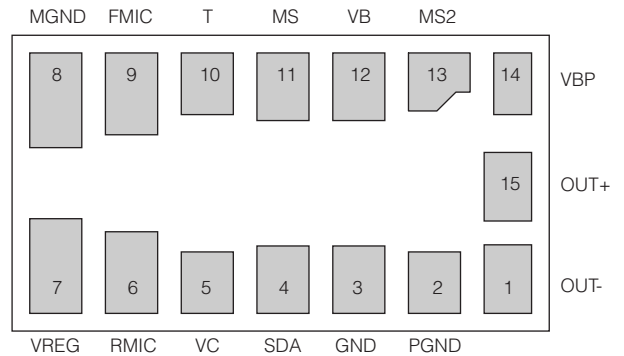


BLOCK DIAGRAM

ABSOLUTE MAXIMUM RATING

Operating Temperature Range:	-10°C to 40°C
Storage Temperature Range:	-20°C to 70°C
Absolute Maximum Power Dissipation:	25mW
Maximum Operating Supply Voltage:	1.5VDC
Absolute Maximum Supply Voltage:	2VDC

PAD CONNECTION



CAUTION
ELECTROSTATIC
SENSITIVE DEVICES
DO NOT OPEN PACKAGES OR HANDLE
EXCEPT AT A STATIC-FREE WORKSTATION



CAUTION
LEVEL 3 MOISTURE
SENSITIVE DEVICES
DO NOT OPEN PACKAGES EXCEPT UNDER
CONTROLLED CONDITIONS



ELECTRICAL CHARACTERISTICS

Conditions: Supply Voltage $V_B = 1.3V$; Temperature = 25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Hybrid Current	I_{AMP}	See current consumption section	-	700	-	μA
Minimum Operating Supply Voltage	V_{BOFF}	Ramp down	0.94	1.0	1.05	V
Supply Voltage turn on threshold	V_{BON}	Ramp up	1.06	1.10	1.16	V
Supply Voltage Hysteresis			90	100	110	mV
Supply Voltage during Communication	V_{BC}	During Communication	1.19	1.35	1.5	V
Hybrid Current during Communication	I_P	Programming (<5 ms)	-	3.7	-	mA
EEPROM Burn Cycles		Note 2	100k	-		cycles
Low Frequency System Bandwidth			100	140	225	Hz
High Frequency System Bandwidth			15.2	16	16.8	kHz
Total Maximum System Gain	A_V	$V_{IN} = -95$ dBV @ 3kHz; squelch disabled See Note 1.	81	83	85	dB
Converter Gain	A_{CONV}	A/D + D/A gain.	27	29	31	dB
Total Harmonic Distortion	THD	$V_{IN} = -40$ dBV	-	0.05	1	%
THD at Maximum Input	THD _M	$V_{IN} = -15$ dBV, HRX - ON	-	1.5	3	%
Clock Frequency	f_{clk}		1.945	2.048	2.151	MHz
REGULATOR						
Regulator Voltage	V_{REG}		0.90	0.95	1.00	V
Regulator Supply Rejection	PSRR _{REG}		-	50	-	dB

ELECTRICAL CHARACTERISTICS (CONTINUED)Conditions: Supply Voltage $V_B = 1.3V$; Temperature = 25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
INPUT						
Input Referred Noise	IRN	Bandwidth 100Hz - 8kHz	-	-108	-106	dBV
Input Impedance	Z_{IN}		11.2	16	22	k Ω
Anti-alias Filter Rejection (input referred)		$f = f_{clk} - 8kHz$, $V_{IN} = -40dBV$	-	80	-	dB
Maximum Input Level			-	-15	-	dBV
Input Dynamic Range		HRX - ON, Bandwidth 100Hz - 8kHz	-	95	-	dB
Audio Sample Rate			30.4	32	33.6	kHz
A/D Dynamic Range		Bandwidth 100Hz - 8kHz	-	86	-	dB
OUTPUT						
Maximum RMS Output Voltage		0dBFS $f = 1kHz$	-3	-1	1	dBV
D/A Dynamic Range		Bandwidth 100Hz - 8kHz	80	-	-	dB
Output Impedance	Z_{OUT}	Note 2	-	-	20	Ω
VOLUME CONTROL						
Volume Control Resistance	R_{VC}		160	200	240	k Ω
Volume Control Range	ΔA		47.5	48	48.5	dB
MS INPUT						
Low State	Lo		0	-	$V_{REG}/3$	V
Open State	Z		$V_{REG}/3$	-	$2V_{REG}/3$	V
High State	Hi		$2V_{REG}/3$	-	V_B	V
MS2 INPUT						
Pull Down Resistance			-	1	-	M Ω
Logic 1 Voltage			V_{REG}	-	V_B	V
Rising Edge Threshold			0.5	0.69	0.9	V
Falling Edge Threshold			0.25	0.45	0.5	V
Hysteresis			0.1	0.24	0.4	V

ELECTRICAL CHARACTERISTICS (CONTINUED)Conditions: Supply Voltage $V_B = 1.3V$; Temperature = 25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
SDA INPUT						
Logic 0 Voltage		Note 2	0	-	0.3	V
Logic 1 Voltage		Note 2	1	-	1.3	V
SDA OUTPUT						
Standby Pull Up Current			1.4	2	2.6	μA
Sync Pull Up Current			450	500	550	μA
Logic 0 Current (Pull Down)			225	250	275	μA
Logic 1 Current (Pull Up)			225	250	275	μA
Synchronization Time (Synchronization Pulse Width)	T_{SYNC}	Baud = 0	237	250	263	μs
		Baud = 1	118	125	132	μs
		Baud = 2	59	62.5	66	μs
		Baud = 3	29.76	31.25	32.81	μs
		Baud = 4	14.88	15.63	16.41	μs
		Baud = 5	7.44	7.81	8.20	μs
		Baud = 6	3.72	3.91	4.10	μs
		Baud = 7	1.86	1.95	2.05	μs

NOTE 1: Total System Gain consists of: *Wideband System Gain + High and Low Independent Channel Gains + Converter Gain*

Total System Gain is calibrated during Cal/Config process.

NOTE 2: Sample tested.

SUPPORT SOFTWARE

All support software for the GB3211 / GB3221 is available
from Gennum Web site:

www.gennum.com/hip/software/index.html.

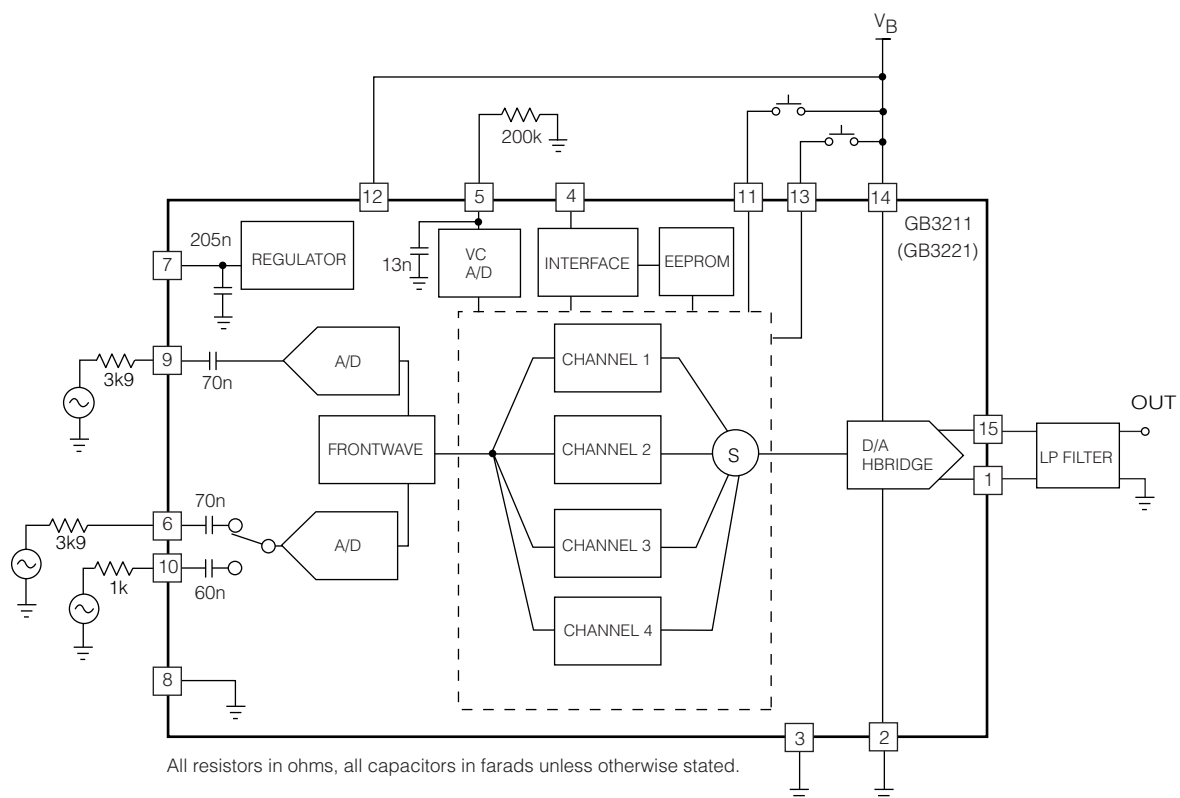


Figure 1: Test Circuit

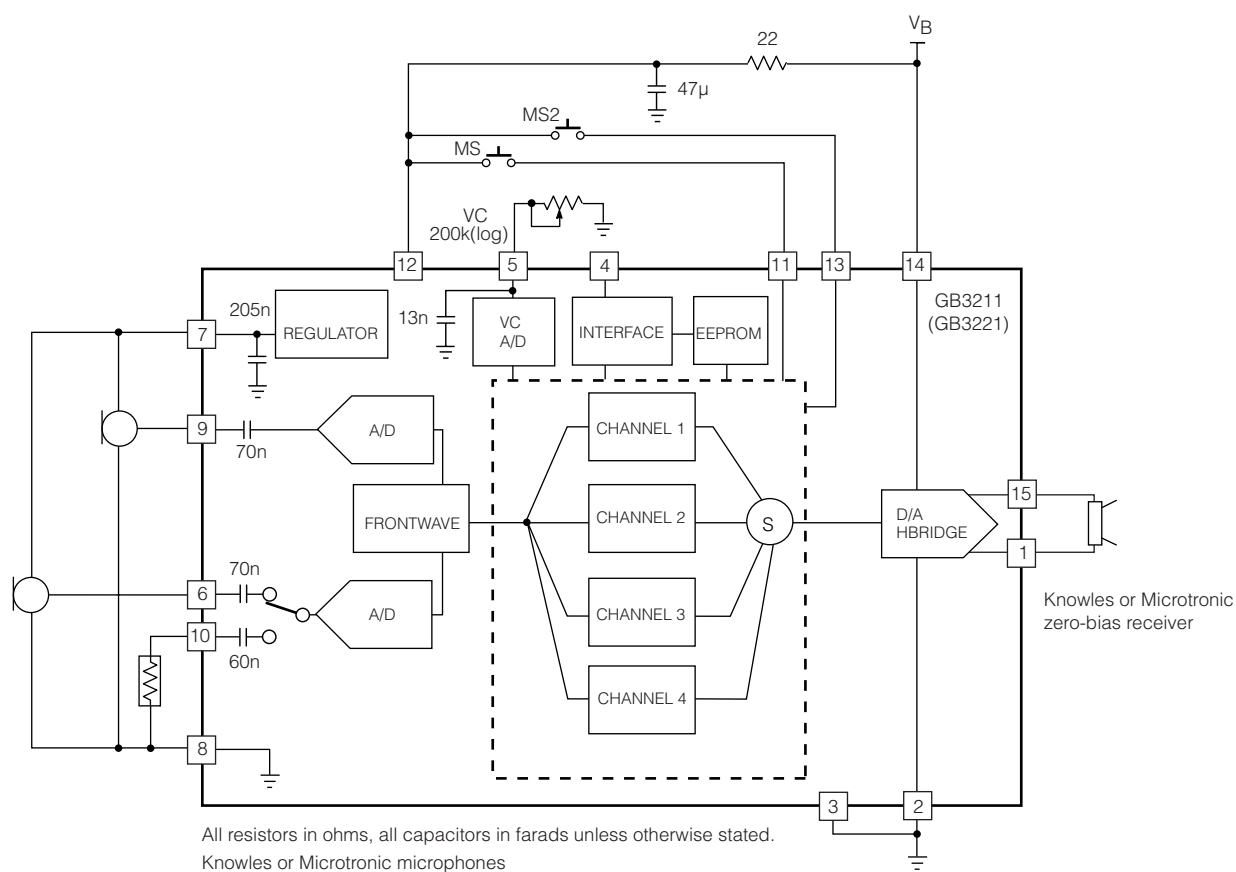


Figure 2: Sample Application Circuit

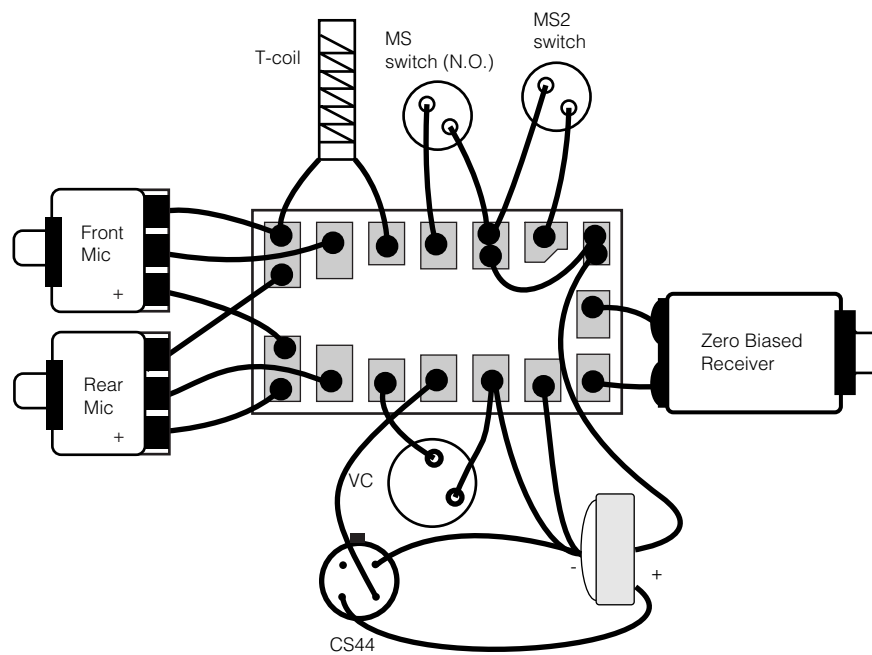
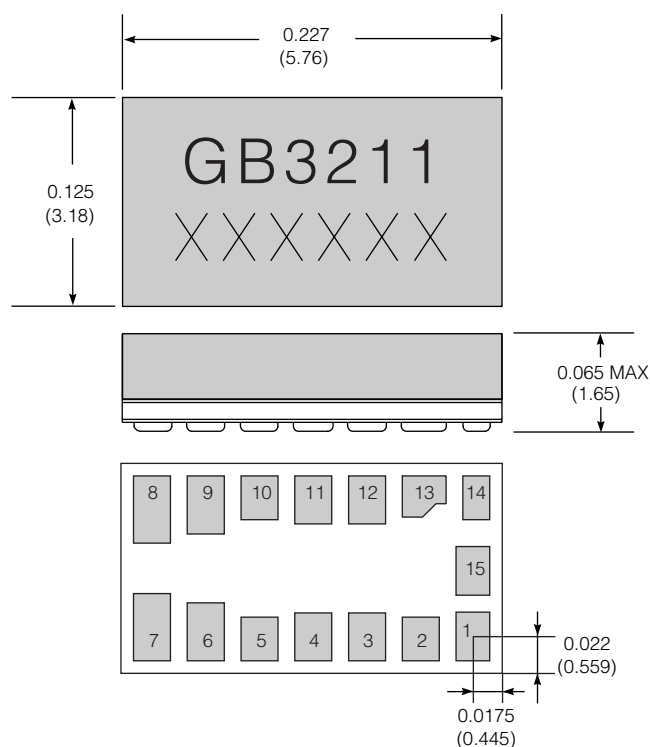


Figure 3: Assembly Diagram

PACKAGE DIMENSIONS



Dimension units are in inches.

Dimensions in parentheses are in millimetres, converted from inches and include minor rounding errors.

1.0000 inches = 25.400mm

Dimension tolerances: ± 0.003 (± 0.08) unless otherwise stated.

Work order number: XXXXXX

This Hybrid is designed for either point-to-point manual soldering or for reflow according to Gennum's reflow process

(Information Note 521-45).

PAD LOCATIONS

PAD NO.	PAD POSITION		PAD DIMENSION		
	X	Y	Xdim	Ydim	
1	0	0	20	29	MIL
2	-31	-1.5	22	26	
3	-63	-0.25	22	28.5	
4	-95	-0.25	22	28.5	
5	-127	-1.5	22	26	
6	-159	2.75	22	34.5	
7	-191	5.5	22	40	
8	-191	75.5	22	40	
9	-159	78.25	22	34.5	
10	-127	82.5	22	26	
11	-95	81.25	22	28.5	
12	-63	81.25	22	28.5	
13	-30	85.5	26	24.5	
14	2	82.5	16	26	
15	0	39	20	29	
1	0	0	0.508	0.737	mm
2	-0.787	-0.038	0.559	0.660	
3	-1.600	-0.006	0.559	0.724	
4	-2.413	-0.006	0.559	0.724	
5	-3.226	-0.038	0.559	0.660	
6	-4.039	0.070	0.559	0.876	
7	-4.851	0.140	0.559	1.016	
8	-4.851	1.918	0.559	1.016	
9	-4.039	1.988	0.559	0.876	
10	-3.226	2.0965	0.559	0.660	
11	-2.413	2.0638	0.559	0.724	
12	-1.600	2.0638	0.559	0.724	
13	0.762	2.172	0.660	0.622	
14	0.051	2.096	0.406	0.660	
15	0	0.991	0.508	0.737	

DOCUMENT IDENTIFICATION

PRELIMINARY DATA SHEET

The product is in production. Gennum reserves the right to make changes at any time to improve reliability, function or design, in order to provide the best product possible.

REVISION NOTES:

GB3221 hybrid code changed.

For latest product information, visit www.gennum.com

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